

IN THE ABSTRACT OF THE DISCLOSURE:

Please amend the Abstract of the Disclosure on page 43 as follows:

A semiconductor manufacturing apparatus ~~comprises~~ includes a light source[[,]] and a lighting device ~~for lighting that lights the light the light source, and a~~ A connector ~~for connecting connects~~ the light source and the lighting device with a metal piece, ~~whereby to provide control of~~ generation of noise accompanying increased electrical power supplied to the lamp is maintained at a level equal to or less than that of conventional arrangements, and control of the space required for installing increasingly larger semiconductor manufacturing apparatuses is maintained at a scale equal to or smaller than that of conventional arrangements, thereby lightening the overall task of installing the semiconductor manufacturing apparatus including cables, improving the efficiency of a cooling device (temperature-adjusting device), and reducing and thus conserving electric power used for the cooling (temperature-adjusting) installation in a single housing having outer walls with electromagnetic shielding. Temperature of the light source and the lighting device is adjusted using air of the ambient atmosphere from outside the housing.